



MSW2T-2040-193/MSW2T-2041-193

SP2T Surface Mount High Power PIN Diode Switch

Features:

- Wide Operating Frequency Band: 50 MHz to 4 GHz
- Surface Mount SP2T Switch – 5mm x 8mm x 2.5mm
- Industry Leading Average Power Handling – 160W CW
- High RF Peak Power - >550W
- Low Insertion Loss (< 0.25 dB) and High IIP3 (>65 dBm)
- High Linearity
- RoHS Compliant

Description:

The MSW2T-204X-193 series SP2T surface mount High Power PIN Diode switches are available in two operating frequency bands: MSW2T-2040-193 operates from 50 MHz to 1 GHz and MSW2T-2041-193 operates from 400 MHz to 4 GHz. The MSW2T-204X-193 series of high power switches leverage high reliability hybrid manufacturing processes which yield both superior RF and thermal characteristics performance compared to MMIC or Glass Carrier based technologies. The hybrid design approach permits precise PIN Diode selection to optimize RF performance while maintaining competitive cost targets. The small form factor (8mm x 5mm x 2.5mm) offers world class power handling, low insertion loss, and superior intermodulation performance exceeding all competitive technologies. The MSW204X-193 family of symmetrical switches are tailored to minimize Transmit to Antenna loss while maximizing Transmit to Receive isolation and to enable maximum flexibility as the designer can assign either port as Transmit Port and the other as the Receive Port. The extremely low thermal resistance of the hybrid assembly permits reliably handling up to 52 dBm CW power and up to 57 dBm peak RF incident power while operating at the $T_{amb (MAX)} = +85^{\circ}C$.

Typical Applications:

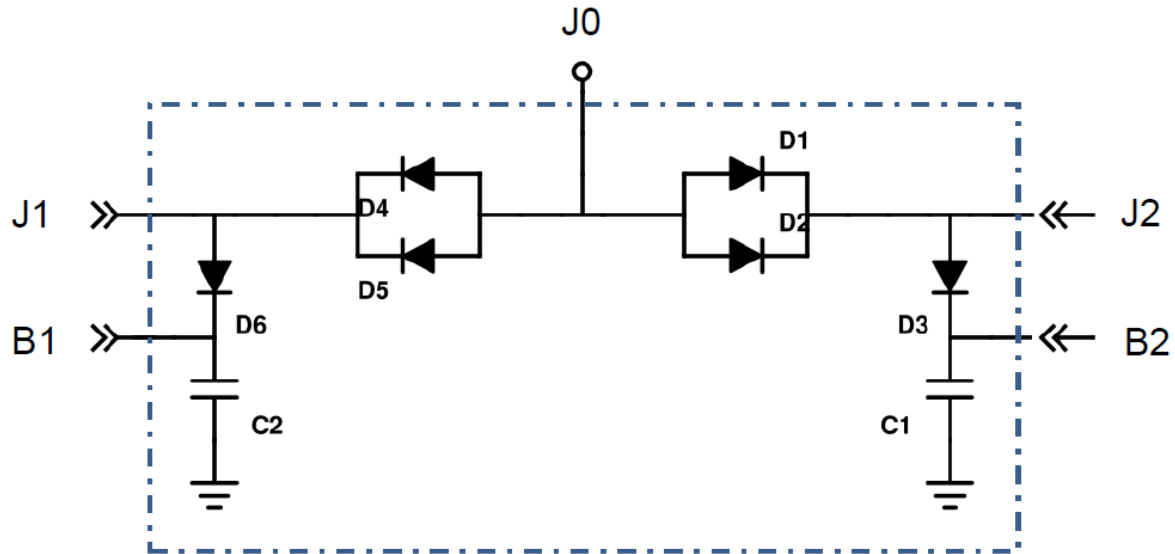
- Radar T/R Modules
- High Power Transmit/Receive Switching
- Switch Bank Filters
- Mil-Com Radios

The MSW2T-204X-193 series of High Power SP2T switches are intended for use in high power, high reliability, mission critical applications from 50 MHz to 4 GHz. The manufacturing process has been proven through decades of extensive use in high reliability applications.

ESD and Moisture Sensitivity Level Rating:

The MSW2T-204X-193 family of SP2T switches are fully RoHS compliant and carry an ESD rating of Class 1C, Human Body Model (HBM) with a moisture sensitivity rating of MSL 1.

MSW2T-204X-193 Schematic



MSW2T-2040-193 Electrical Specifications @ Zo = 50Ω; Ta = +25°C

Parameter	Symbol	Test Condition	Min Value	Typ Value	Max Value	Units
Frequency	F		50		1,000	MHz
Insertion Loss	IL	Bias State 1: port J0 to J1 Bias State 2: port J0 to J2		0.2	0.3	dB
Return Loss	RL	Bias State 1: port J0 to J1 Bias State 2: port J0 to J2	18	20		dB
Isolation	ISO	Bias State 1: port J0 to J1 Bias State 2: port J0 to J2	47	50		dB
CW Incident Power (Note 2)	P _{inc} (CW)	Source & Load VSWR = 1.5:1			52	dBm
Peak Incident Power (Note 2)	P _{inc} (Pk)	Source & Load VSWR = 1.5:1 Pulse width = 10 us, Duty Cycle = 1%			57	dB
Switching Time	t _{sw}	10% to 90% RF Voltage, TTL rep rate = 100 kHz		2	3	usec
Input 3 rd Order Intercept Point	IIP3	F ₁ =500 MHz, F ₂ =510 MHz, P ₁ =P ₂ =10dBm Measured on path biased to low loss state	60	65		dBm

MSW2T-2041-193 Electrical Specifications @ $Z_0 = 50\Omega$; $T_a = +25^\circ\text{C}$

Parameter	Symbol	Test Condition	Min Value	Typ Value	Max Value	Units
Frequency	F		400		4,000	MHz
Insertion Loss	IL	Bias State 1: port J0 to J1 Bias State 2: port J0 to J2		0.5	0.7	dB
Return Loss	RL	Bias State 1: port J0 to J1 Bias State 2: port J0 to J2	14	15		dB
Isolation	ISO	Bias State 1: port J0 to J1 Bias State 2: port J0 to J2	30	33		dB
CW Incident Power (Note 2)	$P_{inc}(CW)$	Source & Load VSWR = 1.5:1			52	dBm
Peak Incident Power (Note 2)	$P_{inc}(Pk)$	Source & Load VSWR = 1.5:1 Pulse width = 10 us, Duty Cycle = 1%			57	dB
Switching Time	t_{sw}	10% to 90% RF Voltage, TTL rep rate = 100 kHz		2	3	usec
Input 3 rd Order Intercept Point	IIP3	$F_1=500$ MHz, $F_2=510$ MHz, $P_1=P_2=10$ dBm Measured on path biased to low loss state	60	65		dBm

MSW2T-204X-193 Absolute Maximum Ratings @ $T_A = +25^\circ\text{C}$ (unless otherwise denoted)

Parameters	Conditions	Absolute Maximum Value
Forward Current – Ant, Tx or Rx Port		250mA
Forward Current – DC Bias Port		100mA
Reverse Voltage – Tx or Rx Port		125V
Reverse Voltage – DC Bias Port		125V
Forward Diode Voltage	$I_F = 250$ mA	1.2V-
Operating Temperature		-65°C to $+125^\circ\text{C}$
Storage Temperature		-65°C to $+150^\circ\text{C}$
Junction Temperature		$+175^\circ\text{C}$
Assembly Temperature		260°C for 10 sec
CW Incident Power Handling – J0-J1 or J0-J2 (Note 1)	Source & Load VSWR = 1.5:1, $T_{CASE} = 85^\circ\text{C}$, cold switching	52 dBm
Peak Incident Power Handling – J0-J1 or J0-J2 (Note 1)	Source & Load VSWR = 1.5:1, $T_{CASE} = 85^\circ\text{C}$, cold switching, Pulse Width = 10 us, Duty Cycle = 1%	57 dBm
Total Dissipated RF & DC Power (note 1)	$T_{CASE} = 85^\circ\text{C}$, cold switching	6 W

Notes:

- 1) Backside RF, DC and Thermal Ground area of device must be completely solder attached to RF circuit board vias for proper electrical and thermal circuit grounding.

Control Conditions Table

	State 1	State 2
Test Condition	J0-J1 in Low Insertion Loss J0-J2 in Isolation	J0-J1 in Isolation J0-J2 in Low Insertion Loss
B1	V_{HIGH} , 0 mA	0 V, -25 mA
B2	0 V, -25 mA	V_{HIGH} (note 2), 0 mA
J0	~0.9 V, +150 mA	~0.9 V, +150mA
J1	0 V, -150 mA	V_{HIGH} (note 2), +25 mA
J2	V_{HIGH} (note 2), 25 mA	0 V, -150 mA

Notes:

- Switching time from 50% TTL to 10% or 90% RF Voltage is a function of the PIN diode driver circuit performance as well as the characteristic of the PIN diode. An RC (current spiking network) is used on the driver circuit output to provide a large transient current spike to rapidly remove stored charge from the PIN diode's intrinsic layer. Typical component values are : R = 50 to 220Ω and C = 470 to 1,000 pF.
- PIN diode minimum reverse DC voltage (V_{HIGH}) is used to maintain high resistance in the OFF PIN diode state and is determined by RF frequency, incident power, duty cycle, characteristic impedance and VSWR as well by the characteristics of the PIN diode. The recommended minimum value of the reverse bias voltage (V_{HIGH}) value is provided in the Minimum Reverse Bias Voltage Table shown below.

Control Truth Table for MSW2T-204X-193

$+V_{cc1} = 5V$ and $+V_{cc2} = 28V$ (unless otherwise noted)

Ant – Tx Path	Ant – Rx Path	Bias J1 (notes 1 & 2)	Bias J2 (notes 1 & 2)	B1 Bias (notes 1 & 2)	B2 Bias (notes 1 & 2)
Low Loss	Isolation	$V = 0 V$, $I = -150 mA$	$V = V_{HIGH}$, $I = +100 mA$	$V = V_{HIGH}$ $I = 0 mA$	$V = 0V$ $I = -25 mA$
Isolation	Low Loss	$V = V_{HIGH}$, $I = +25 mA$	$V = 0 V$, $I = -150 mA$	$V = 0 V$, $I = -25 mA$	$V_{HIGH}+28 V$ $I = 0 mA$

Notes:

- $28 V \leq V_{HIGH} \leq 125V$
- PIN diode min reverse DC voltage (V_{HIGH}) to maintain high resistance state in the OFF PIN diode is determined by RF frequency. Incident power, duty cycle, characteristic impedance and VSWR as well as by characteristics of the diode. The recommended min reverse bias voltage (V_{HIGH}) values are provided in the Min Reverse Bias Voltage Table of this data sheet.

RF Bias Network Recommended Component Values

Part Number	Operating Frequency (MHz)	DC Blocking Capacitors	Inductors	RF Bypass Capacitors
MSW2T-2040-193	50 – 1,000	0.1 uF	4.7 uH	0.1 uF
MSW2T-2041-193	400 – 4,000	27 pF	82 nH	270 pF

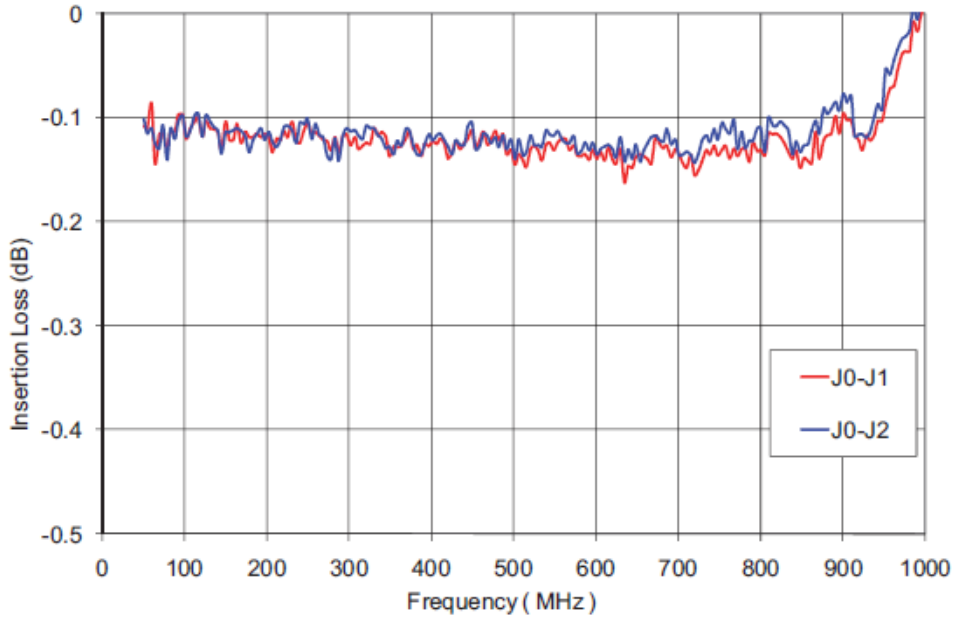
MSW2T-204X-193 Minimum Reverse Bias Voltage Table

Part Number	Frequency of Operation (MHz)					
	50	100	200	400	1,000	4,000
MSW2T-2040-193	125V	125V	85V	55V	28V	N/A
MSW2T-2041-193	N/A	N/A	125V	85V	55V	28V

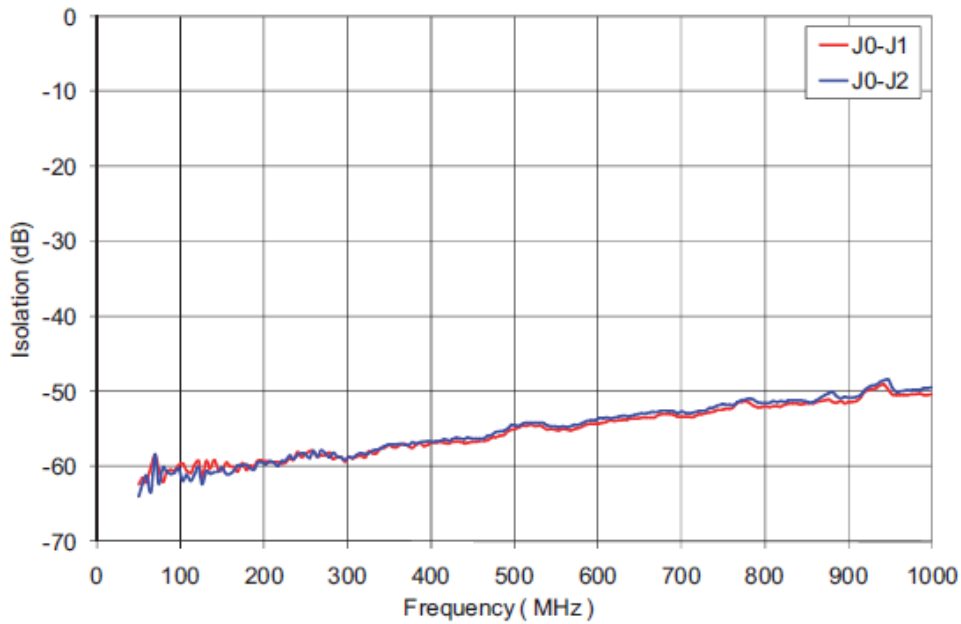
Note: N/A denotes an operating frequency outside the normal switch operating frequency range.

MSW2T-2040-193 Small Signal Parametric Performance:

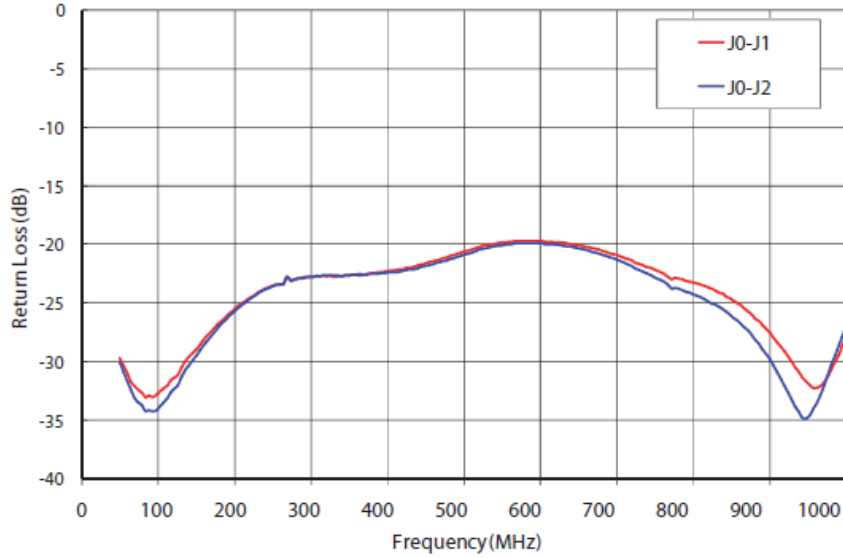
MSW2T-2040-193: Insertion Loss



MSW2T-2040-193: Isolation

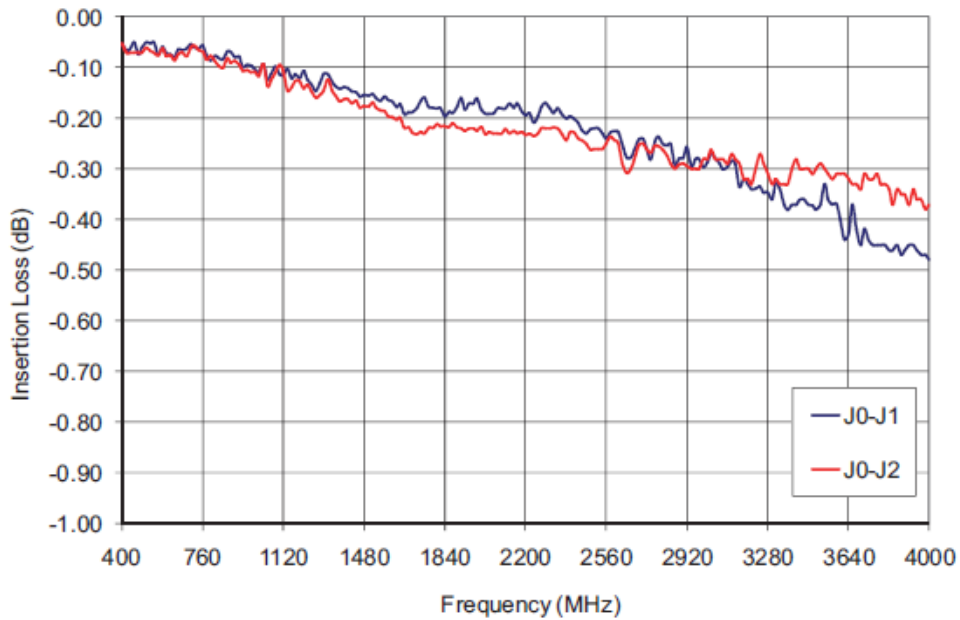


MSW2T-2040-193: Return Loss

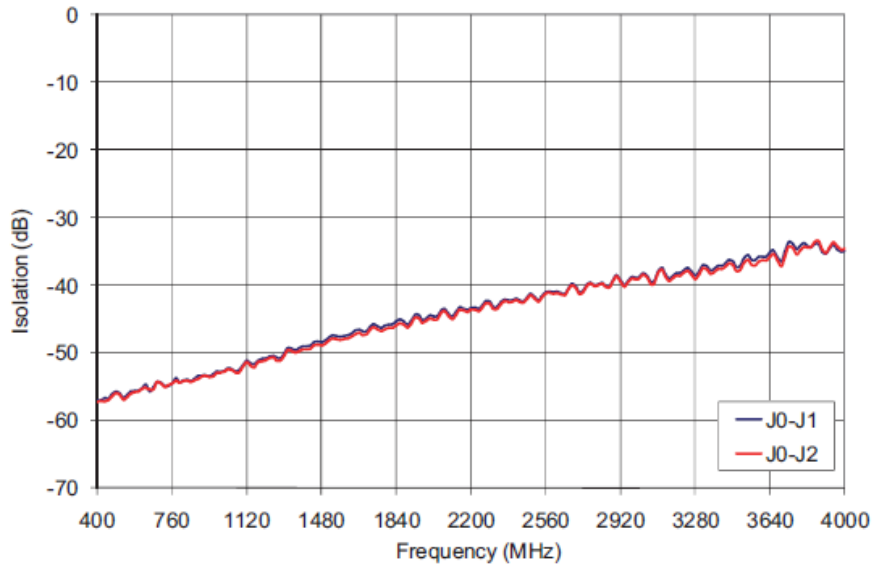


MSW2T-2041-193: Small Signal Parametric Performance:

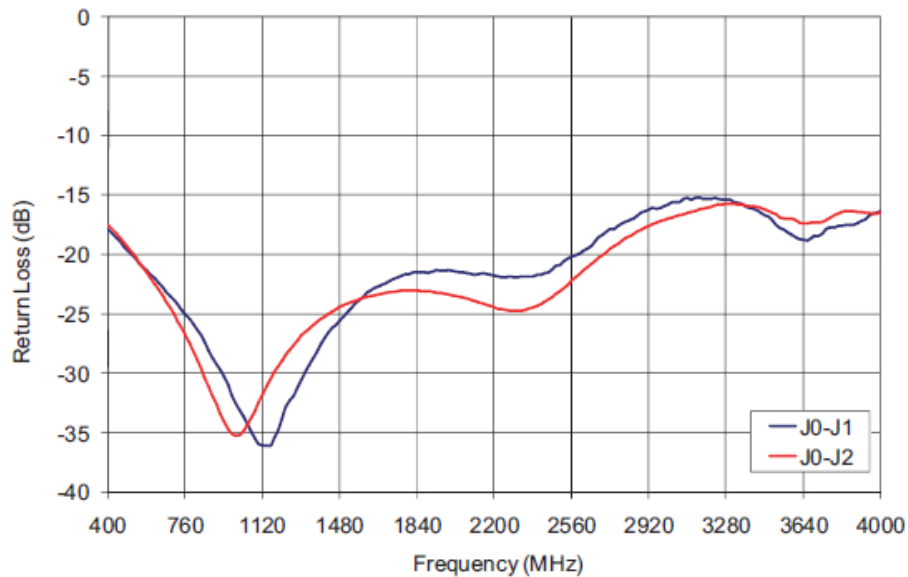
MSW2T-2041-193: Insertion Loss



MSW2T-2041-193: Isolation



MSW2T-2041 Return Loss

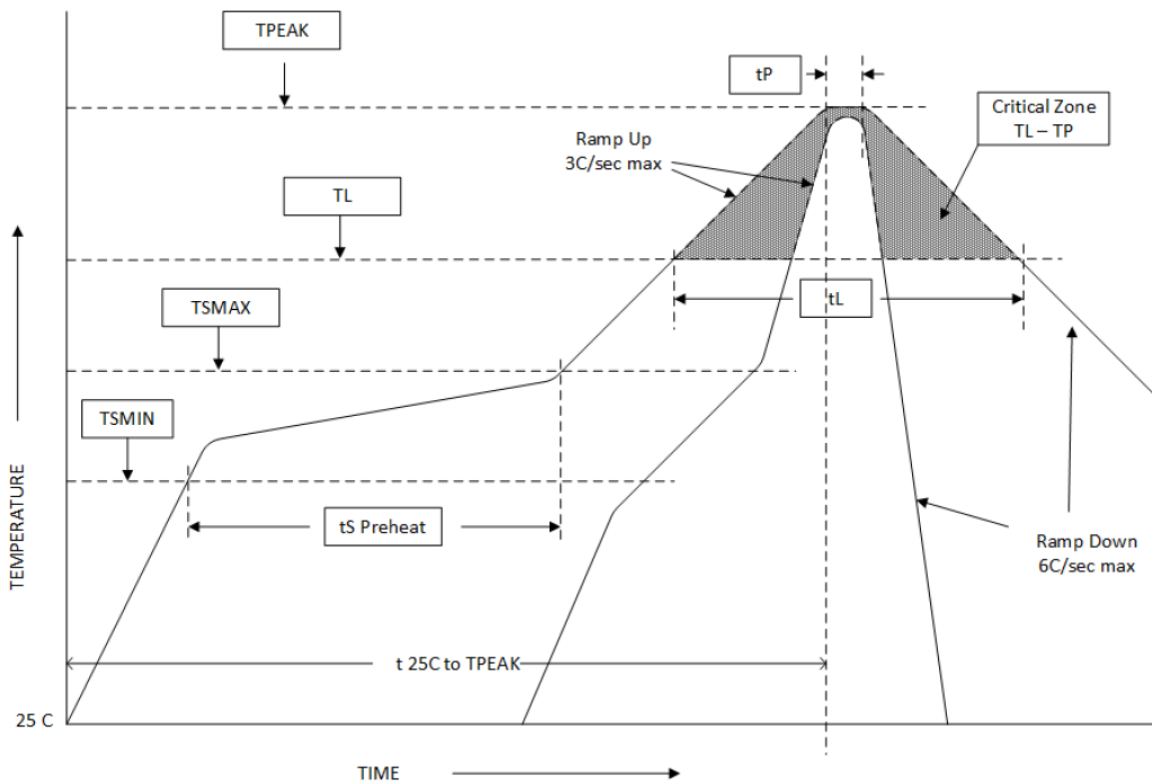


Assembly Instructions

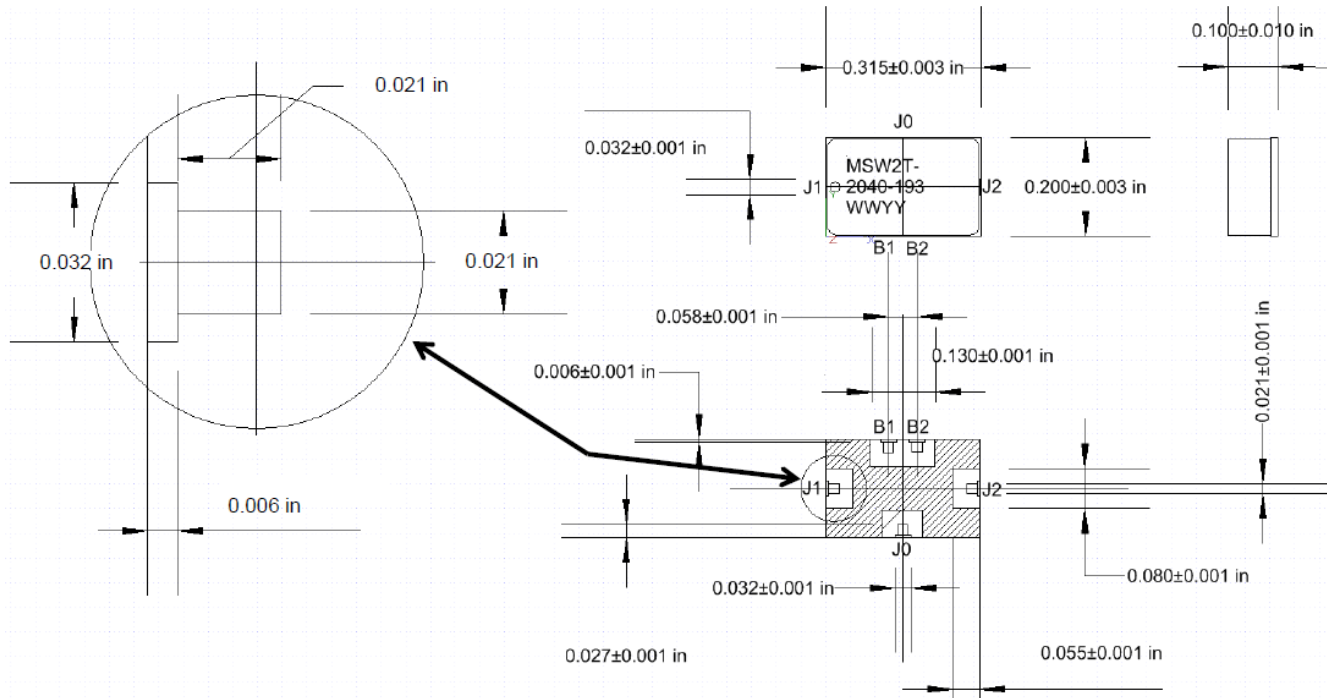
The MSW2T-204X-193 may be attached to the printed circuit card using solder reflow procedures using either RoHS or Sn63/ Pb37 type solders per the Table and Temperature Profile Graph shown below:

Profile Parameter	Sn-Pb Assembly Technique	RoHS Assembly Technique
Average ramp-up rate (T_L to T_P)	3°C/sec (max)	3°C/sec (max)
Preheat		
Temp Min (T_{smin})	100°C	150°C
Temp Max (T_{smax})	150°C	200°C
Time (min to max) (t_s)	60 – 120 sec	60 – 180 sec
T_{smax} to T_L		
Ramp up Rate		3°C/sec (max)
Peak Temp (T_P)	225°C +0°C / -5°C	260°C +0°C / -5°C
Time within 5°C of Actual Peak Temp (T_P)	10 to 30 sec	20 to 40 sec
Time Maintained Above:		
Temp (T_L)	183°C	217°C
Time (t_L)	60 to 150 sec	60 to 150 sec
Ramp Down Rate	6°C/sec (max)	6°C/sec (max)
Time 25°C to T_P	6 minutes (max)	8 minutes (max)

Solder Re-Flow Time-Temperature Profile



MSW2T-204X-193 SP2T Package Outline Drawing

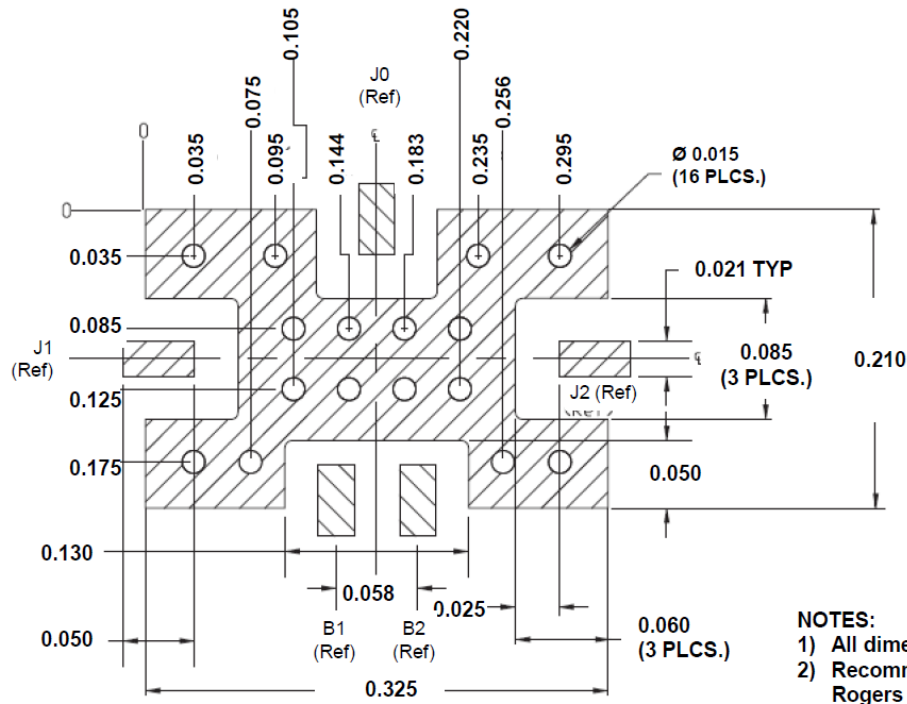


Note: Metalized area on backside is the RF, DC and Thermal ground. In user's end application this surface temperature must be managed to meet the power handling requirements.

Thermal Design Considerations:

The design of the MWT-204X-193 family of High Power Switches permits the maximum efficiency in thermal management of the PIN Diodes while maintaining extremely high reliability. Optimum switch performance and reliability of the switch can be achieved by the maintaining the base ground surface temperature of less than 85°C.

Recommended RF Circuit Solder Footprint for the MSW2T-204X-193



Part Number Ordering Details:

The MSW2T-204X-193 family of High Power Switches are available in either tube or Tape & Reel format.

Part Number	Packaging
MSW2T-2040-193	Tube
MSW2T-2040-193TR	Tape & Reel (250 pcs)
MSW2T-2041-193	Tube
MSW2T-2041-193TR	Tape & Reel (250 pcs)